

Surface Mount ESD Capability Rectifiers

SlimSMA



Top View

Bottom View

DO-221AC

PRIMARY CHARACTERISTICS

$I_{F(AV)}$	2.0 A
V_{RRM}	100 V, 200 V, 400 V, 600 V
I_{FSM}	35 A
V_F at $I_F = 2.0$ A ($T_A = 125$ °C)	0.86 V
I_R	5 μ A
T_J max.	175 °C
Package	DO-221AC (SlimSMA)
Diode variations	Single die

TYPICAL APPLICATIONS

General purpose, power line polarity protection, in both consumer and automotive applications.

FEATURES

- Very low profile - typical height of 0.95 mm
- Ideal for automated placement
- Oxide planar chip junction
- Low forward voltage drop, low leakage current
- ESD capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



RoHS
COMPLIANT
HALOGEN
FREE

MECHANICAL DATA

Case: DO-221AC (SlimSMA)

Molding compound meets UL 94 V-0 flammability rating
Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 1A whisker test, HM3 suffix meets JESD 201 class 2 whisker test

Polarity: Color band denotes the cathode end

MAXIMUM RATINGS ($T_A = 25$ °C unless otherwise noted)

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PARAMETER	SYMBOL	SE20AFB	SE20AFD	SE20AFG	SE20AFJ	UNIT
Device marking code		S2B	S2D	S2G	S2J	
Maximum repetitive peak reverse voltage	V _{RRM}	100	200	400	600	V
Maximum DC forward current	I _F ⁽¹⁾	2.0				A
	I _F ⁽²⁾	1.3				
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I _{FSM}	35				A
Operating junction and storage temperature range	T _J , T _{STG}	-55 to +175				°C

Notes

(1) Mounted on 5.0 mm x 5.0 mm pad areas, 2 oz. FR4 PCB

(2) Free air, mounted on recommended copper pad area



ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	I _F = 1.0 A	T _A = 25 °C	V _F ⁽¹⁾	0.91	-	V
	I _F = 2.0 A			0.96	1.1	
	I _F = 1.0 A	T _A = 125 °C		0.79	-	
	I _F = 2.0 A			0.86	0.98	
Reverse current	Rated V _R	T _A = 25 °C	I _R ⁽²⁾	-	5.0	μA
		T _A = 125 °C		8	100	
Typical reverse recovery time	I _F = 0.5 A, I _R = 1.0 A, I _{rr} = 0.25 A		t _{rr}	1.2	-	μs
Typical junction capacitance	4.0 V, 1 MHz		C _J	12	-	pF

Notes(1) Pulse test: 300 μs pulse width, 1 % duty cycle(2) Pulse test: Pulse width $\leq 40\text{ ms}$

THERMAL CHARACTERISTICS (T _A = 25 °c unless otherwise noted)						
PARAMETER	SYMBOL	SE20AFB	SE20AFD	SE20AFG	SE20AFJ	UNIT
Typical thermal resistance	R _{θJA} ⁽¹⁾	125				°C/W
	R _{θJM} ⁽²⁾	12				

Notes(1) Free air, mounted on recommended PCB, 1 oz. pad area; thermal resistance $R_{\theta JA}$ - junction to ambient(2) Mounted on 5.0 mm x 5.0 mm pad areas, 2 oz. FR4 PCB; $R_{\theta JM}$ - junction to mount

IMMUNITY TO ELECTRICAL STATIC DISCHARGE TO THE FOLLOWING STANDARDS ($T_A = 25\text{ }^{\circ}\text{C}$ unless otherwise noted)					
STANDARD	TEST TYPE	TEST CONDITIONS	SYMBOL	CLASS	VALUE
AEC-Q101-001	Human body model (contact mode)	$C = 100\text{ pF}$, $R = 1.5\text{ k}\Omega$	V_C	H3B	$> 8\text{ kV}$

ORDERING INFORMATION (Example)				
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
SE20AFJ-M3/6A	0.032	6A	3500	7" diameter plastic tape and reel
SE20AFJ-M3/6B	0.032	6B	14 000	13" diameter plastic tape and reel
SE20AFJHM3/6A ⁽¹⁾	0.032	6A	3500	7" diameter plastic tape and reel
SE20AFJHM3/6B ⁽¹⁾	0.032	6B	14 000	13" diameter plastic tape and reel

Note

(1) AEC-Q101 qualified



RATINGS AND CHARACTERISTICS CURVES ($T_A = 25^\circ\text{C}$ unless otherwise noted)

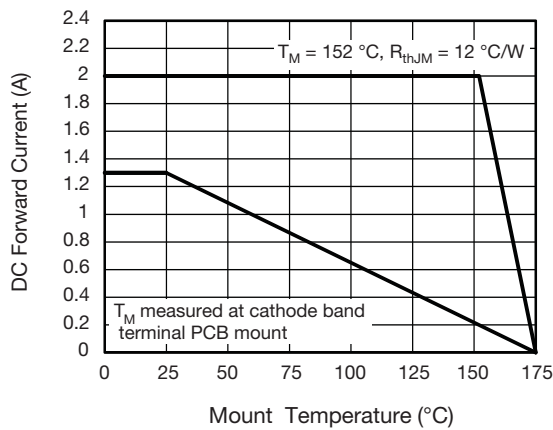


Fig. 1 - Maximum Forward Current Derating Curve

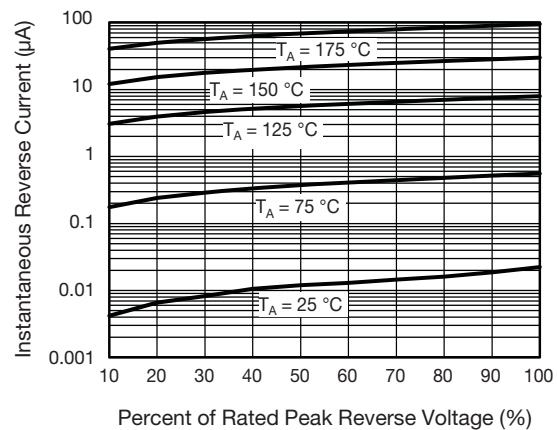


Fig. 4 - Typical Reverse Leakage Characteristics

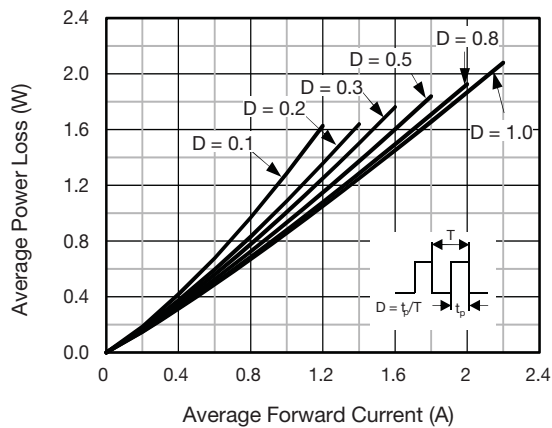


Fig. 2 - Forward Power Loss Characteristics

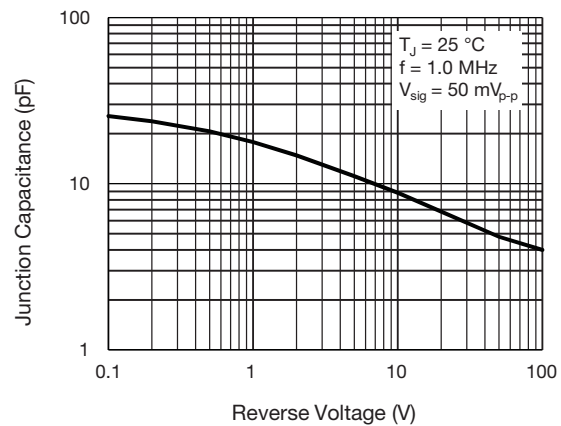


Fig. 5 - Typical Junction Capacitance

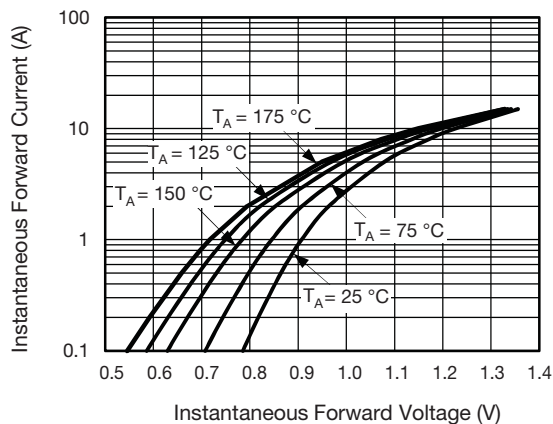


Fig. 3 - Typical Instantaneous Forward Characteristics

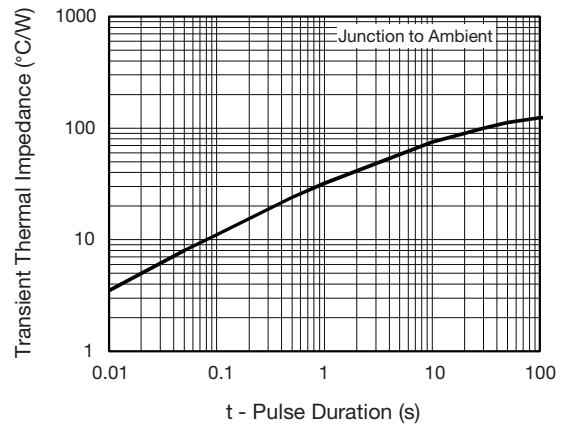


Fig. 6 - Typical Junction Capacitance

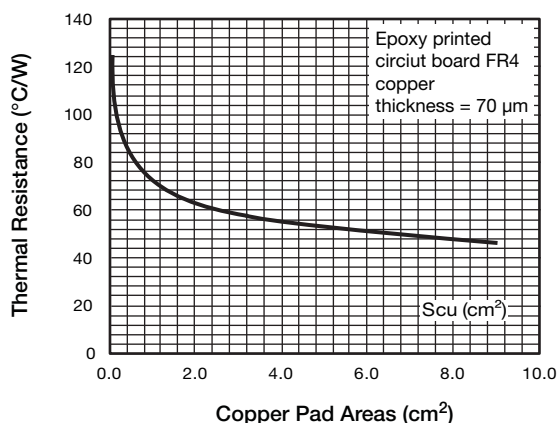
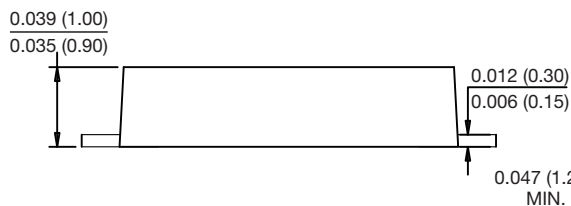
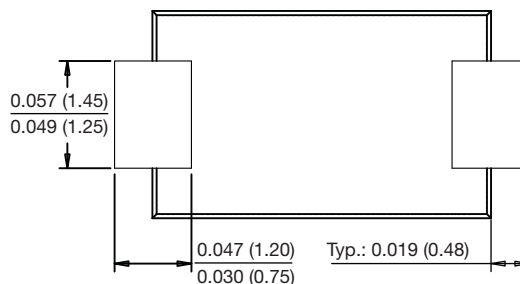
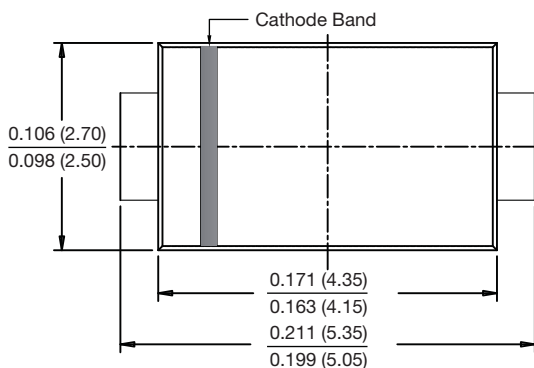


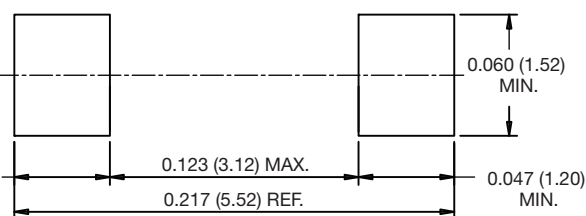
Fig. 7 - Thermal Resistance Junction to Ambient vs. Copper Pad Areas

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

DO-221AC (SlimSMA)



Mounting Pad Layout





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